

Multi-Cal-Interface PCA Evaluation Module

This user's guide describes the characteristics, operation, and the use of the Multi-Cal-Interface PCA evaluation module (EVM). It covers all pertinent areas involved to properly use this printed circuit assembly (PCA), including details regarding hardware design and usage. The document includes the physical printed circuit board (PCB) layout, schematic diagrams, and circuit descriptions.

Contents

1	Overview	2
2	Theory of Operation for Multi-Cal-Interface PCA Hardware	4
3	Multi-Cal-Interface PCA Configuration	5
4	Bill of Materials	11

List of Figures

1	Hardware Included with the Multi-Cal-Interface PCA EVM Kit.....	2
2	Multi-Cal-Interface Block Diagram	4
3	24-Channel Multi-Cal-System Example.....	5
4	16-Channel Multi-Cal-System Example.....	6
5	Using the Screwless Terminal Blocks.....	6
6	Connecting the Multi-Cal-Test Boards	7
7	Multi-Cal-Interface Jumper Configuration.....	8
8	Jumper-Selected Output Mode.....	8

List of Tables

1	Signal Definitions on P0.....	9
2	Signal Definitions on P1	10
3	Multi-Cal-Interface PCA EVM Parts List	11

1 Overview

The Multi-Cal-Interface PCA Evaluation Module is a set of EVMs that is used to calibrate multiple [PGA308 sensor modules](#). The PGA308 is a programmable analog sensor signal conditioner. All components in the Multi-Cal-Interface can be expanded to calibrate up to 64 sensors simultaneously. For a more detailed description of the PGA308, refer to the product data sheet ([SBOS440](#)) available from the Texas Instruments web site at <http://www.ti.com>. Additional support documents are listed in the section of this guide entitled *Related Documentation from Texas Instruments*.

The Multi-Cal-Interface is part of a set of evaluation modules that is used to calibrate multiple PGA308 sensor modules. The complete Multi-Cal-System contains a series of PCAs, and can be expanded to meet your specific system requirements.

Throughout this document, the abbreviation *EVM* and the term *evaluation module* are synonymous with the Multi-Cal-Interface PCA Evaluation Module.

1.1 Multi-Cal-Interface PCA Hardware Options

[Figure 1](#) shows the hardware included with the Multi-Cal-Interface PCA. Contact the factory if any component is missing.

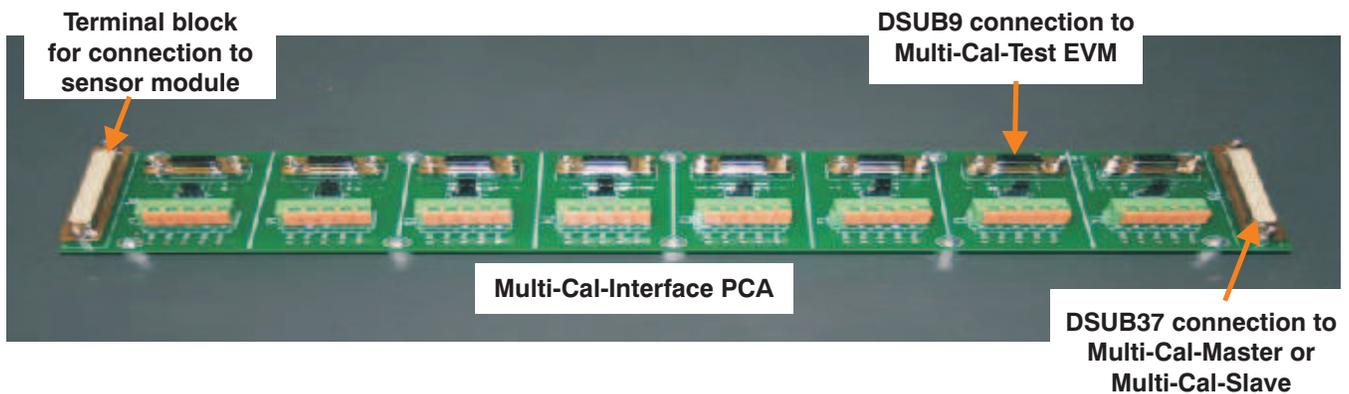


Figure 1. Hardware Included with the Multi-Cal-Interface PCA EVM Kit

The Multi-Cal-Interface PCA provides a way to connect sensor modules to the calibration system. The Multi-Cal-Interface includes a *screwless* terminal block to connect wires from the sensor module. It also includes DSUB9 connectors for connection of the Multi-Cal-Test PCA. Signals from the Multi-Cal-Master or Multi-Cal-Slave are delivered via two, 37-pin DSUB connectors.

1.2 Related Documentation from Texas Instruments

The following document provides information regarding Texas Instruments integrated circuits used in the assembly of the Multi-Cal-Interface PCA EVM. This user's guide is available from the TI website under literature number [SBOU093](#). Any letter appended to the literature number corresponds to the document revision that is current at the time of the writing of this document. Newer revisions may be available from the TI web site at <http://www.ti.com/>, or call the Texas Instruments Literature Response Center at (800) 477-8924 or the Product Information Center at (972) 644-5580. When ordering, identify the document by both title and literature number.

Document	Literature Number
PGA308 Product Data Sheet	SBOS440
XTR115 Product Data Sheet	SBOS124A
USB DAQ Platform User's Guide	SBOU056
Multi-Cal-System EVM User's Guide	SBOU087
Multi-Cal-Test User's Guide	SBOU088
Multi-Cal-Master EVM User's Guide	SBOU089
Multi-Cal-Slave EVM User's Guide	SBOU094
Multi-Cal-Cable User's Guide	SBOU092

1.3 Electrostatic Discharge Warning

Many of the components on the Multi-Cal-Interface PCA are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

CAUTION

Failure to observe ESD handling procedures may result in damage to EVM components.

1.4 Applications Questions

If you have questions about this or other Texas Instruments evaluation modules, post a question in the *Amplifiers* forum at <http://e2e.ti.com>. Include in the subject heading the product in which you are interested.

2 Theory of Operation for Multi-Cal-Interface PCA Hardware

2.1 Multi-Cal-Interface PCA

Figure 2 shows the block diagram of the Multi-Cal-Interface PCA. Note that channels 0 to 3 signals are connected to J0; channels 4 to 7 are connected to J1.

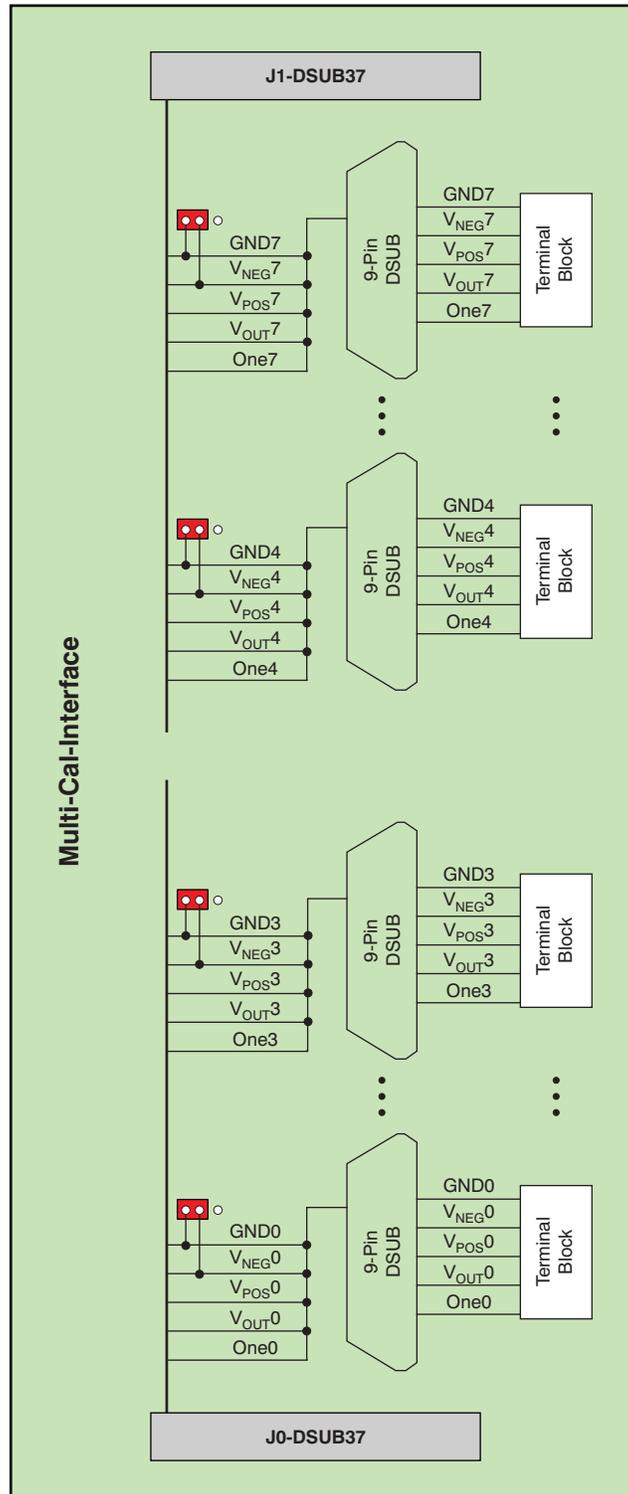


Figure 2. Multi-Cal-Interface Block Diagram

3 Multi-Cal-Interface PCA Configuration

3.1 Connection with Multi-Cal-System

Figure 3 shows a block diagram of the Multi-Cal-System configured to calibrate pressure sensors. Note that this system uses three Multi-Cal-Interface boards, so it can calibrate a maximum of 24 sensors (in other words, $3 \times 8 = 24$). The Multi-Cal-Interface board is designed to be placed adjacent to rows of sensors (for example, pressure manifolds between the interface boards). The Multi-Cal-Interface board is also designed to be placed in an oven (-55°C to $+125^{\circ}\text{C}$).

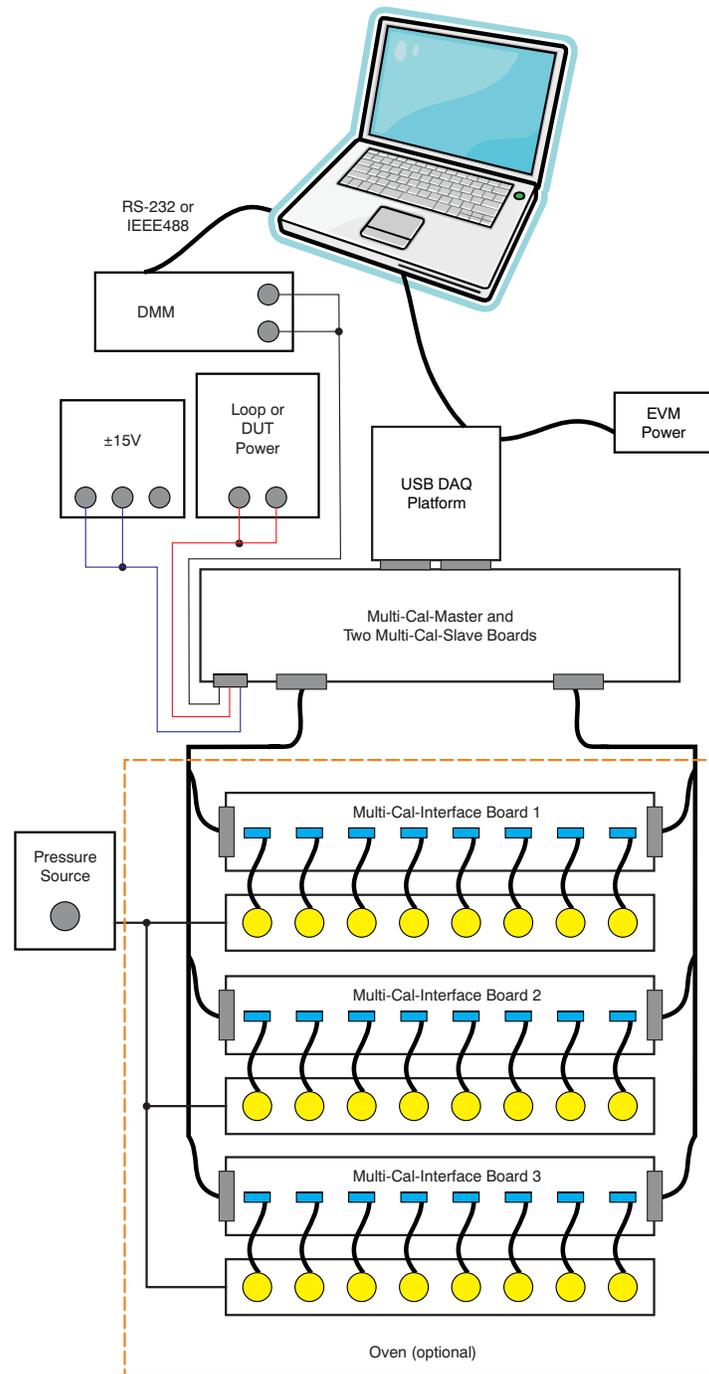


Figure 3. 24-Channel Multi-Cal-System Example

Figure 4 is a photograph of a 16-channel system. Note that two rows of interface boards are connected to four cables. In this example, test boards act as the sensor modules. A final application typically has sensor modules between the two interface boards.

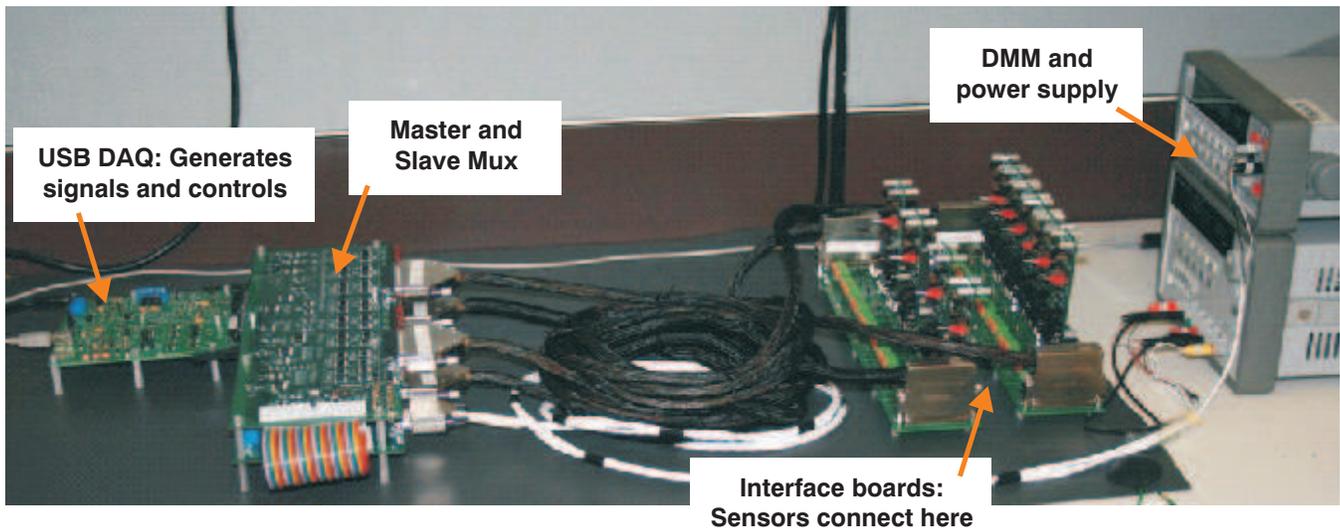


Figure 4. 16-Channel Multi-Cal-System Example

Figure 5 illustrates how wiring from a real-world sensor is connected to the screwless terminal blocks. A screwdriver can be used to push down the spring tab to open the contact area for insertion of a wire.

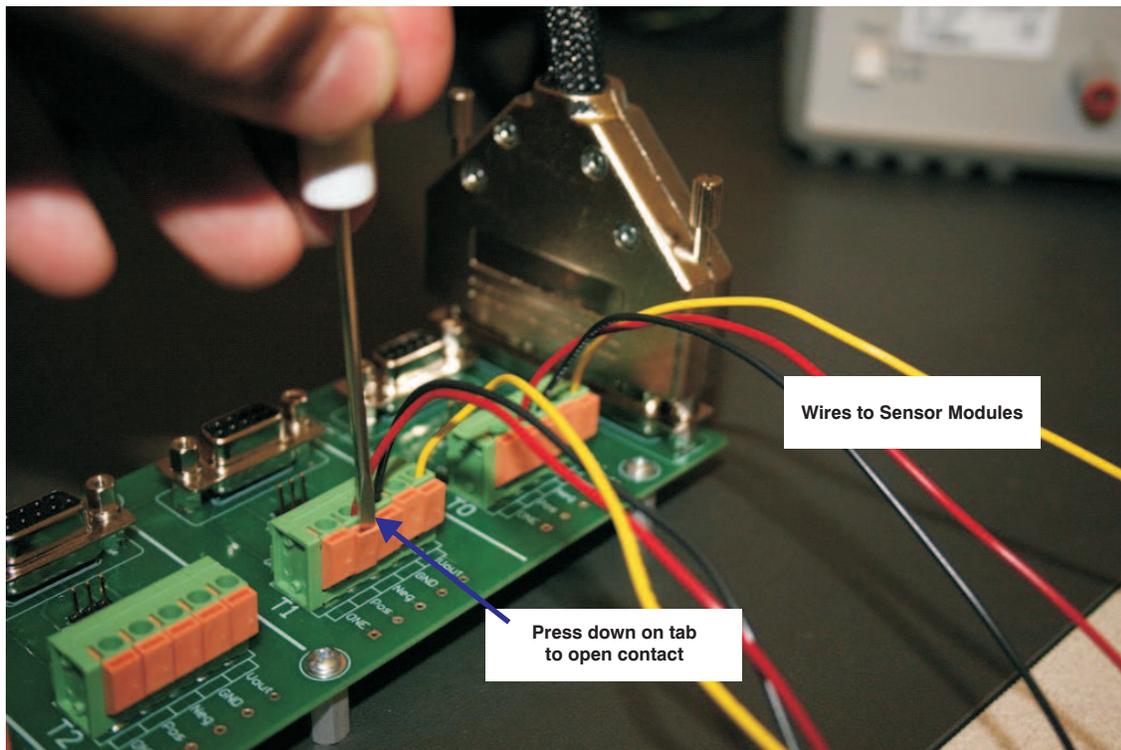


Figure 5. Using the Screwless Terminal Blocks

Within the Multi-Cal-System architecture, the Multi-Cal-Test boards are used for system verification. [Figure 6](#) shows how several Multi-Cal-Test modules can be plugged directly into the interface board.

**DSUB9 allows connection of
Multi-Cal-Test PCA Card**

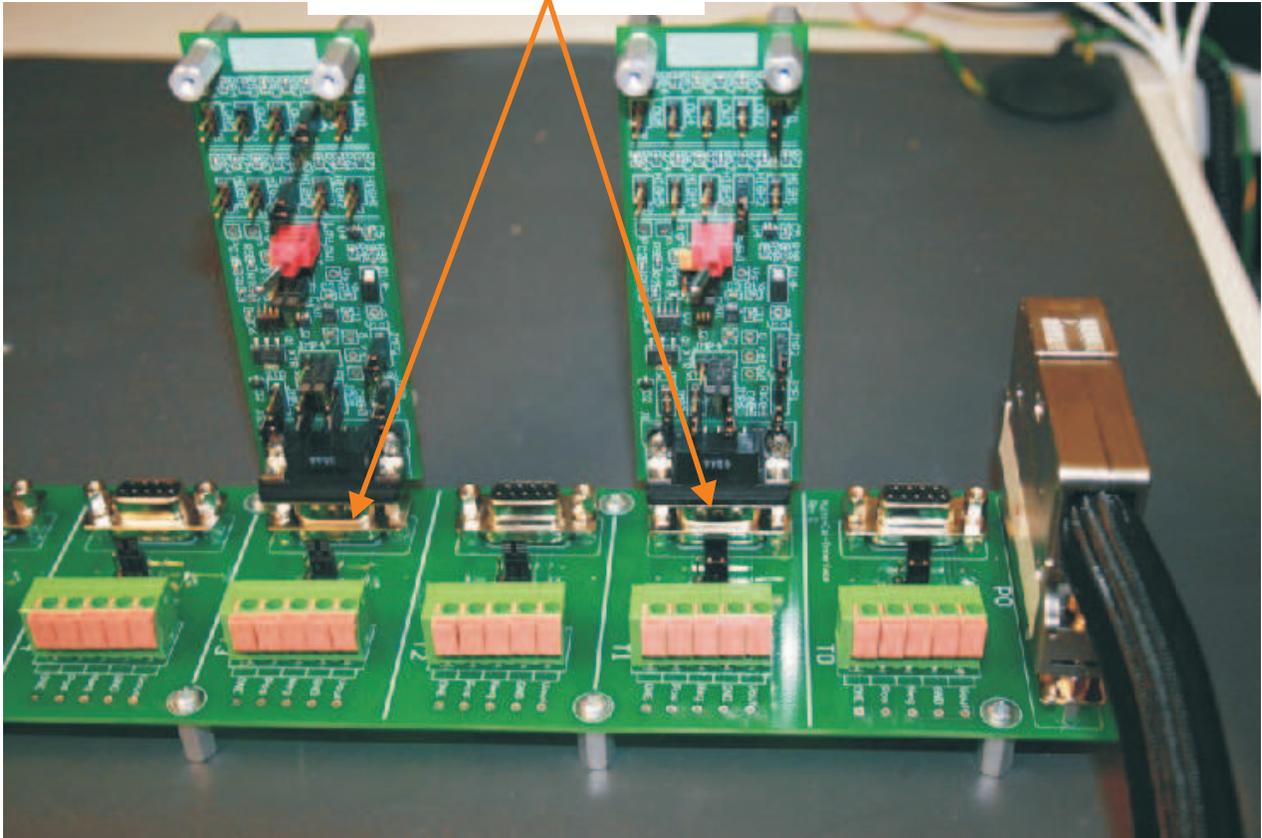


Figure 6. Connecting the Multi-Cal-Test Boards

Figure 7 shows the jumpers on the Multi-Cal-Interface board. The jumper is used to select between *voltage out* and *current out* modes. In current output mode, the jumper is not connected. In voltage output mode, the jumper shorts ground to the negative supply. Figure 8 illustrates a block diagram of the jumper-selected output mode.

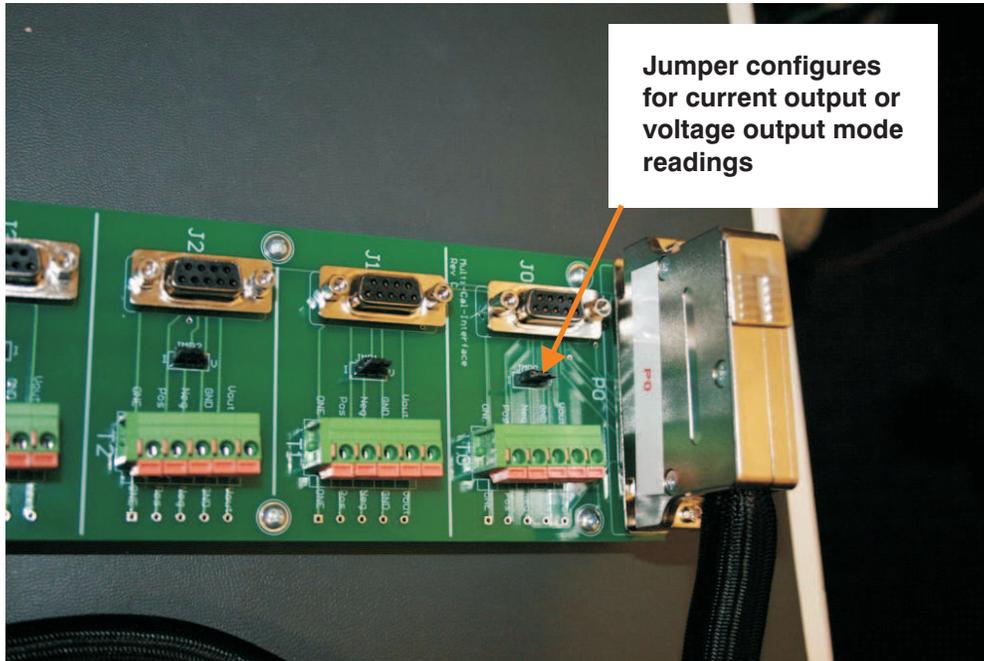


Figure 7. Multi-Cal-Interface Jumper Configuration

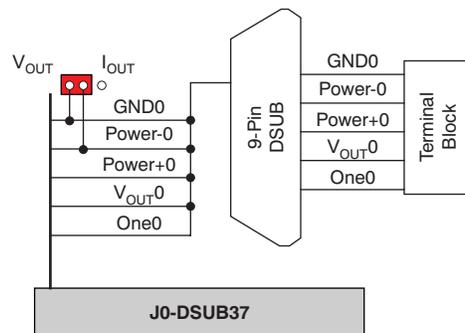


Figure 8. Jumper-Selected Output Mode

3.2 Signal Definitions

Table 1 and Table 2 summarize the signal definitions on the Multi-Cal-Interface cable.

Table 1. Signal Definitions on P0

Pin P0	Signal	Function on P0
1	Chassis ground	Chassis ground
2	One0	One-wire digital communication line.
3	Pos0	Positive device supply.
4	Neg0	Negative device supply.
5	GND0	Ground force for current modules. Ground sense for voltage modules.
6	V _{OUT} 0	Output voltage measurement.
7	SCK0	SPI SCK for XTR108
8	CS0	SPI CS0 for XTR108
9	IO0	SPI Input / Output for XTR108
10	Chassis ground	Pins 10 to 18 repeat the function of pins 1 to 9 for channel 2
11	One1	
12	Pos1	
13	Neg1	
14	GND1	
15	V _{OUT} 1	
16	SCK1	
17	CS1	
18	IO1	
19	—	No connection
20	Chassis ground	Pins 20 to 28 repeat the function of pins 1 to 9 for channel 3
21	One2	
22	Pos2	
23	Neg2	
24	GND2	
25	V _{OUT} 2	
26	SCK2	
27	CS2	
28	IO2	
29	Chassis ground	Pins 29 to 37 repeat the function of pins 1 to 9 for channel 4
30	One3	
31	Pos3	
32	Neg3	
33	GND3	
34	V _{OUT} 3	
35	SCK3	
36	CS3	
37	IO3	

Table 2. Signal Definitions on P1

Pin P1	Signal	Function on P1
1	Chassis ground	Chassis ground
2	One4	One-wire digital communication line.
3	Pos4	Positive device supply.
4	Neg4	Negative device supply.
5	GND4	Ground force for current modules. Ground sense for voltage modules.
6	V _{OUT} 4	Output voltage measurement.
7	SCK4	SPI SCK for XTR108.
8	CS4	SPI CS0 for XTR108
9	IO4	SPI Input / Output for XTR108
10	Chassis ground	Pins 10 to 18 repeat the function of pins 1 to 9 for channel 2
11	One5	
12	Pos5	
13	Neg5	
14	GND5	
15	V _{OUT} 5	
16	SCK5	
17	CS5	
18	IO5	
19	—	No connection
20	Chassis ground	Pins 20 to 28 repeat the function of pins 1 to 9 for channel 3
21	One6	
22	Pos6	
23	Neg6	
24	GND6	
25	V _{OUT} 6	
26	SCK6	
27	CS6	
28	IO6	
29	Chassis ground	Pins 29 to 37 repeat the function of pins 1 to 9 for channel 4
30	One7	
31	Pos7	
32	Neg7	
33	GND7	
34	V _{OUT} 7	
35	SCK7	
36	CS7	
37	IO7	

4 Bill of Materials

Table 3 shows the parts list for the Multi-Cal-Interface PCA EVM.

Table 3. Multi-Cal-Interface PCA EVM Parts List

Qty	Ref Des	Description	Vendor	Part Number
2	P0, P1	Connector, DB37 female solid dip nickel	Norcomp Inc.	172-E37-213R911
8	J0, J1, J2, J3, J4, J5, J6, J7	Connector, DB9 female dip, solid nickel	Norcomp Inc.	171-009-213R911
8	T0, T1, T2, T3, T4, T5, T6, T7	Terminal block, 5-position, top entry, 5.08mm	Tyco Electronics	1776260-5
8	JMP0, JMP1, JMP2, JMP3, JMP4, JMP5, JMP6, JMP7	Connector, Header 50-position .100" SGL Gold	Samtec Inc	SSW-150-02-T-S
8	JMP0, JMP1, JMP2, JMP3, JMP4, JMP5, JMP6, JMP7	Shunt LP w/Handle, 2-position 30AU	Tyco Electronics	881545-2
6	N/A	Standoffs, Hex , 4-40 Threaded, 0.500" length, 0.250" OD, Aluminum iridite finish	Keystone	2203
6	N/A	Machine Screw, 4-40x3/8" Phillips pan head, Steel, Zinc-plated	Building Fasteners	PMS 440 0038 PH

Evaluation Board/Kit Important Notice

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. **THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.**

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user **is not exclusive.**

TI assumes **no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein.**

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit www.ti.com/esh.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 5.7V to 9V and the output voltage range of 0V to 5V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than +25°C. The EVM is designed to operate properly with certain components above +25°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2010, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Communications and Telecom	www.ti.com/communications
DSP	dsp.ti.com	Computers and Peripherals	www.ti.com/computers
Clocks and Timers	www.ti.com/clocks	Consumer Electronics	www.ti.com/consumer-apps
Interface	interface.ti.com	Energy	www.ti.com/energy
Logic	logic.ti.com	Industrial	www.ti.com/industrial
Power Mgmt	power.ti.com	Medical	www.ti.com/medical
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Space, Avionics & Defense	www.ti.com/space-avionics-defense
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video and Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless-apps

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2010, Texas Instruments Incorporated